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Fully inkjet-printed two-dimensional material fieldeffect heterojunctions for wearable and textile electronics

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Fully printed wearable electronics based on two-dimensional (2D) material heterojunction structures also known as heterostructures, such as field-effect transistors, require robust and reproducible printed multi-layer stacks consisting of active channel, dielectric and conductive contact layers. Solution processing of graphite and other layered materials provides low-cost inks enabling printed electronic devices, for example by inkjet printing. However, the limited quality of the 2D-material inks, the complexity of the layered arrangement, and the lack of a dielectric 2D-material ink able to operate at room temperature, under strain and after several washing cycles has impeded the fabrication of electronic devices on textile with fully printed 2D heterostructures. Here we demonstrate fully inkjet-printed 2D-material active heterostructures with graphene and hexagonal-boron nitride (h-BN) inks, and use them to fabricate all inkjet-printed flexible and washable field-effect transistors on textile, reaching a field-effect mobility of ~91 cm² V⁻¹ s⁻¹, at low voltage (<5 V). This enables fully inkjet-printed electronic circuits, such as reprogrammable volatile memory cells, complementary inverters and OR logic gates.

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lexible and textile electronics are rapidly growing research fields. Several applications in these fields have been developed over the past two decades, such as organic lightemitting diodes (OLED), photovoltaic devices and transistors^{1, 2}. Textile electronics can primarily be grouped into two categories, electronic fibres (e-fibres) and 'smart' textiles. E-fibres involve multi-stacking functional layers on the fibres themselves³ or combining functional fibres together to create a device⁴. Smart textiles involve the assembly of components on to the weave of the textile and can be done in several ways either through the assembly of components on substrates which can subsequently be placed on textile⁵ or by fabricating devices on the weave of the textile itself⁶.

Many electronic components, such as thermoelectric power generators, sensors, energy storage, antennas and light-emitting devices, have been printed onto textiles for application in curtain lighting⁷, self-heating seats⁸ or wearable electronics (i.e. the integration of electronics with clothes), for monitoring or security purposes, such as motion sensors⁹, health monitoring¹⁰ and radio-frequency communication¹¹. Inkjet printing is a forefront technique for printed electronics¹². Inks based on organic polymers and metal oxides can be inkjet-printed enabling large-scale manufacturing of transistors on a wide range of plastic substrates. However, both printed metal oxides and organic polymer inks have limited charge mobility (μ) (~ 0.01 – 10 cm² V⁻¹ s⁻¹), which has restricted their prospects to specific applications such as radio-frequency identification tags and control electronics for active matrix displays^{13, 14}. Despite their huge potential, there have been only few attempts to deposit field-effect transistors (FETs) onto textiles, such as by coating organic FETs on polymer fibres to create logic inverters¹⁵, or spin-coating organic FETs on a textile modified with polyurethane/photo acryl layer, achieving μ of 0.05 cm² V⁻¹ s⁻¹ and on/off ~ 10⁵, respectively¹⁶.

The exfoliation of layered materials¹⁷, such as graphite, has driven a surge in the exploration of graphene and more recently other two-dimensional (2D) materials with unique electrical, mechanical, optical and thermal properties¹⁸. Atomically thin 2D materials, such as graphene and hexagonal-boron nitride (h-BN) can be arranged into heterostructures, thus creating assemblies with novel properties which are different from those of the individual components^{17, 18}. The different combination of conducting, insulating and semiconducting 2D materials allows for a large number of different heterostructures with precisely tailored properties with multiple functionalities and improved performance for novel applications¹⁸. Layered materials can be exfoliated in solution by liquid phase exfoliation (LPE)^{19, 20} or microfluidization²¹ and developed into single or multi-layer 2Dmaterial inks. Graphene and 2D-material printable inks have already shown great potential in the field of printed electronics enabling devices such as thin film transistors²², photodetectors²³, sensors⁹, supercapacitors²⁴, saturable absorbers²⁵ and solar cells²⁶. Layered structures of 2D-material inks can then be printed in part or as a whole by means of different printing technologies such as inkjet, spray, screen, gravure and flexographic printing¹². In particular, inkjet printing is an ideal tool to print graphene inks enabling FETs^{22, 24} with mobility of up to $95 \text{ cm}^2 \text{ V}^{-1} \text{ s}^{-1}$ on surface-modified Si/SiO₂ substrate²² and MoS₂ photodetectors on Si/SiO_2 substrate with photoresponsivity of ~36 μAW^{-1} and photocurrent of ~ 57 pA^{27} . Inkjet-printed flexible graphene/MoS₂ photodetectors on polyethylene terephthalate (PET) showed photoresponsivity of ~500 nAW^{-1} and photocurrent of ~ 30 nA²³, and more recently inkjet-printed vertically stacked graphene/WS₂ photodetector were reported with a photoresponsivity up to ~ 1 mAW⁻¹²⁸. More recently, ref. ²⁹ demonstrated current modulation in MoS₂, WS₂, MoSe₂ and WSe₂-printed thin films using electrochemical gating by liquid electrolyte²⁹ rather than by

heterostructure-based dielectric gating, thus requiring ultra-high vacuum and low temperature for correct device operation, which limits its application to flexible electronics. Moreover, the use of a spray-coated h-BN layer as a porous separator, and not as a dielectric layer may fail to be considered an all-printed 2D-material active heterostructure.

Several issues also still exist in the optimisation of 2D-material inkjet-printed multi-laver heterostructures, which have impeded the inkjet printing of 2D-material-based dielectrically gated fieldeffect devices, such as FETs. The main manufacturing issue is that the common solvents (e.g N-methyl-2-pyrrolidone-NMP, dimethylformamide-DMF) used for 2D-material-based inks are toxic and when printed the different 2D materials in the stack tend to redisperse at the interface if solvent is present, producing uncontrolled interfaces, thus strongly affecting the uniformity of the multi-layer deposition³⁰. In addition, the concentration of 2D materials in these solvents is low $(<1 \text{ mg ml}^{-1})^{31}$, thus requiring many print passes to obtain functional films³⁰. Another limitation reported, especially with the use of high boiling point solvents is the required annealing during printing or in post-processing for solvent removal³², which poses severe limitations when printing on plastic or textiles. Similar issues are also present in the case of water-based 2D-material-based inks, where the surfactants/polymers removal requires thermal and/or chemical treatments³³, which are often not compatible with the substrate.

In this work, we demonstrate washable, flexible graphene/h-BN FETs all inkjet-printed with non-toxic, low boiling point inks on polyester textile, and demonstrate its viability for smart textile and printed integrated circuits working at room temperature and pressure. The devices achieved an average field-effect mobility of $\mu_n = 150 \pm 18 \text{ cm}^2 \text{ V}^{-1} \text{ s}^{-1}$ when printed in a coplanar structure on PET and $\mu_h = 91 \pm 29 \text{ cm}^2 \text{ V}^{-1} \text{ s}^{-1}$ on polyester textile.

Results

Ink formulation. In this study we used a drop-on-demand (DoD) inkjet printer. The ink viscosity η (mPa s), surface tension γ (mN m⁻¹), density ρ (g cm⁻³) and the nozzle diameter *a* (µm) influence the jetting of individual drops from a nozzle³⁴. On the one hand, suitable inkjet printable ink formulations, which are produced by LPE^{19, 20} typically contain surfactants or polymer stabilisation agents, which can act as a source of contamination and may hinder device performance, however they can also positively impact the ink by acting as an adhesion or rheology modifier²¹. On the other hand, high boiling point solvents (>100 °C), such as NMP can suspend 2D materials without stabilisation agents due to a matching of the Hansen solubility parameters^{19, 20}. However, they are still far from ideal as they are based on toxic and expensive solvents, which require high annealing temperatures (>100 °C) to remove residual solvent²⁸. Low boiling point inks (≤ 100 °C) are a suitable alternative, due to their fast evaporation at room temperature and have been reported to create stable inks though two solvent formulation where the solvent mixture is tuned to improve the affinity of the solvent to the 2D materials³⁵. However, the different evaporation rate of the two solvents can result in rheological instabilities and particle aggregation over time. We select an alternative ink formulation route based on solvent exchange, whereby layered materials can be exfoliated effectively in a high boiling point solvent and subsequently transferred to a low boiling-point solvent, with any desired concentration³⁶.

We formulated the graphene and h-BN inks (see 'Methods') with the following rheological parameters (η , γ and ρ), $\eta_{h-BN} \sim 1.7 \text{ mPa s}$, $\gamma_{h-BN} \sim 72 \text{ mN m}^{-1}$, $\rho_{h-BN} \sim 1.01 \text{ g cm}^{-3}$, $\eta_{GR} \sim 1 \text{ mPa s}$, $\gamma_{GR} \sim 30 \text{ mN m}^{-1}$, $\rho_{GR} \sim 0.82 \text{ g cm}^{-3}$, which are consistent with previous reports¹⁹, 20, 22</sup>. The inverse Ohnesorge



Fig. 1 Flakes characterisation. **a** Optical absorption of the graphene and h-BN inks shown in the inset. Atomic force microscopy statistics indicating the thickness (**b**) and the lateral flake size distribution (**c**) for the graphene and h-BN inks. **d** Scanning electron microscopy images of the graphene flakes ~ 200 nm, (inset) starting graphite ~ 400 µm. **e** h-BN flakes ~ 516 nm and (inset) starting bulk h-BN ~ 5 µm. Transmission electron microscopy micrographs of few layer graphene (**f**) and h-BN (**g**) flakes

number (Oh) is used as a figure of merit, $Z = Oh^{-1} = (\gamma \rho a)^{1/2}/\eta$ and is commonly used to characterize the drop formation, stability and assess the jettability of an ink from the nozzle^{34, 37}. An overall range of 2 < Z < 24 has been identified as an optimal range for printing^{22, 37}. We found $Z \sim 19.4$ and $Z \sim 22$ for the h-BN and graphene inks, respectively, which fall within the optimal Z range^{22, 37}.

Optical absorption spectroscopy (Fig. 1a) was used to estimate the flake concentration^{19, 20} c, obtaining $c_{h-BN} \sim 0.44$ mg ml⁻¹ and $c_{GR} \sim 0.42$ mg ml⁻¹ for h-BN (red curve) and graphene (black curve), respectively. The spectra for the graphene ink is mostly featureless due to the linear dispersion of the Dirac electrons³⁸, whereas the peak in the UV region is a signature of the an Hove singularity in the graphene density of states³⁸. The spectra for the h-BN ink shows a peak located at 218 nm, which corresponds to the interband transitions in the density of states³⁹ revealing an optical bandgap, E_g of 5.69 eV (see 'Methods'), which is consistent with previous reports determining the optical band gap for thin h-BN films^{40, 41}.

The lateral size $\langle \langle S \rangle$ and thickness (*t*) of the graphene and h-BN flakes was estimated by atomic force microscopy (AFM). Figure 1b shows the statistics of the peak thicknesses extracted from AFM over 150 individual flakes (examples in Supplementary Fig. 1) of graphene and h-BN. The log-normal distribution⁴² is peaked at $t \sim 6$ nm and $t \sim 9$ nm and assuming an approximate 1 nm water layer²⁹ and an interlayer distance of 0.34 nm, we calculate that the solutions consist of an average number of layers, $N \sim 15$ and $N \sim 24$ for graphene and h-BN, respectively^{43, 44}. The $\langle S \rangle$ distributions of the flakes contained in each ink (Fig. 1c), defined⁴² as $\langle S \rangle = \sqrt{xy}$, where *x* and *y* are the length and width of the flake were also investigated to verify that the flake dimensions match with the inkjet requirements for DoD inkjet ($\langle S \rangle \sim 50$ times smaller than *a* to avoid nozzle clogging). The lateral size

distributions follow a log-normal distribution⁴², which is peaked at ~121 and ~495 nm for graphene and h-BN flakes, respectively. Scanning electron microscopy (SEM) was also used to corroborate the lateral size of the flakes in the inks (Fig. 1d, e). A statistical analysis over 20 flakes for the h-BN and graphene ink (Supplementary Fig. 2a, b), in this case indicates an average $\langle S \rangle$ of ~520 \pm 60 nm and $\langle S \rangle$ ~ 110 \pm 11 nm, respectively, verifying the AFM statistics and the DoD requirements. In each case, we also found that $\langle S \rangle$ of the bulk material (inset Fig. 1d, e) decreases upon exfoliation by an order of magnitude for the h-BN and more than three orders of magnitude for the graphite, from ~5 and ~400 µm, respectively, indicating the exfoliation of the bulk material into platelets. Figure 1f and g shows transmission electron microscopy (TEM) micrographs of few layer graphene flakes and a terraced h-BN flake and from the graphene and h-BN inks, respectively. The associated TEM statistics (Supplementary Fig. 2c, d) show $\langle S \rangle \sim 760$ nm and $\langle S \rangle \sim 120$ nm for the h-BN and graphene inks, respectively, which are comparable with the values obtained from AFM and SEM.

Inkjet-printed graphene/h-BN field-effect heterostructures on PET. We first investigated the dielectric properties of the h-BN ink in a Ag/h-BN/Ag parallel plate capacitor configuration (Supplementary Fig. 3a–e). From the impedance spectra (more details in Supplementary Note 1) of an inkjet-printed capacitor with an area (A_c) of 500 µm² and t of 1.2 µm, we estimate a capacitance per unit area is 8.7 nF cm⁻², which is consistent with the 0.24 to 1.1 nF cm⁻² range previously reported⁴⁵. Before moving to the textile substrate, we investigated top-gate (coplanar) and bottom-gate (inverted-staggered) FET structures and optimised the inkjet-printed graphene/h-BN heterostructures on a PET substrate (Novele, Novacentrix), which was coated with



Fig. 2 Inkjet-printed coplanar FET on PET. **a** Schematic of a printed coplanar FET heterostructure. HAADF-STEM cross-sectional view of the regions in the red dashed line (**b**) and blue dashed line (**c**). Multivariate analysis of the cross section in the blue region showing non-negative matrix factorization loadings and factors (insets) (**d**-**i**). The red box in **g** indicates the presence of the carbon (i.e. graphene) film. **j** Raman Spectroscopy of the printed coplanar FET heterostructure

SiO₂ nanoparticles (to increase the absorption of residual solvent away from the devices). The coplanar FET heterostructure is shown in the schematics in Fig. 2a. We first inkjet-printed the transistor channel ($t \sim 100$ nm, measured with AFM on Si/SiO₂) with the graphene ink. Ref. 22 determined the percolation threshold of the graphene flakes forming a graphene film at t ~ 25 nm^{22} on a Si/SiO₂ substrate ($R_q = 0.1 nm$, determined by AFM), so for our graphene/h-BN FETs on a rougher PET substrate (R_a = 68 nm) we print a thicker graphene channel to ensure that graphene flakes fall above the percolation threshold. The source and drain are then printed ($t \sim 500$ nm) using a silver ink (Sigma-Aldrich, 736465) ($Z \approx 3$). The gate dielectric layer was then inkjet-printed with the h-BN ink forming a film of $t \sim 1.2 \,\mu\text{m}$ and was placed under vacuum overnight at room temperature to remove any bubbles that may be trapped inside the dielectric⁴⁶. Finally, a silver top-gate ($t \sim 200$ nm) electrode was inkjet-printed on the structure and the sample was annealed on a hot plate at 100 °C for 1 h to remove residual solvent. Using the same printing conditions (see 'Methods'), the inverted-staggered FET heterostructures were fabricated by printing a silver gate ($t \sim 500$ nm), then the h-BN dielectric $(t \sim 1.2 \,\mu\text{m})$ followed by the graphene channel ($t \sim 100$ nm) and finally defining the source and drain electrodes with silver ink ($t \sim 200$ nm), arrays of these devices can be observed in Supplementary Fig. 4a and b.

The morphology and the local chemical composition of the coplanar graphene/h-BN FET devices were investigated using high angle anular dark-field-scanning transmission electron microscopy/energy dispersive X-ray (HAADF-STEM/EDX) analysis. Two lamellae, each ~200 nm wide, were prepared from the coplanar device using focused ion beam (FIB) milling. The cross-sections of the graphene/h-BN FET were extracted from the

channel region (red dashed line in Fig. 2a) and from the top/ bottom contact region (blue dashed line in Fig. 2a). HAADF-STEM images were acquired on a FEI Tecnai Osiris. The architecture of the channel region is displayed in Fig. 2b, containing the PET substrate, h-BN flakes and the top silver electrode. Figure 2c shows the graphene/h-BN heterostructure sandwiched between drain (bottom) and gate (top) silver electrodes. In both cases, the thickness of the h-BN dielectric is approximately $t \sim 1.1 \,\mu\text{m}$, consistent with the profilometer analysis for four printing passes discussed in Supplementary Note 1. The h-BN flakes are clearly identifiable and show a preferential alignment along the direction of the channel. The large lateral dimension of our h-BN flakes (peaked at 495 nm) and their orientation ensure significant overlap amongst the flakes, preventing the formation of pin-holes (i.e connections from the top contact to the channel) in the dielectric region⁴⁵. We performed EDX analysis of the lamellae to identify the local chemical composition along the cross section of the heterostructure. The identification of the graphene layer $(t \sim 100 \text{ nm})$ from the STEM images is very challenging due to its thickness and the coexistence of carbon throughout the layers. In the EDX spectra, the carbon signal is generated both from carboxymethylcellulose sodium salt (CMC), used as stabilisation polymer, and the graphene layer. Therefore, the identification of the carbon presence in the EDX maps is not a good marker for univocally identifying the graphene flakes within the device. Hence, we employed multivariate analysis (see 'Methods') to localise EDX signals from compounds, rather than individual elements (Fig. 2d-i) and discriminate between the two carbon-containing phases.



Fig. 3 Inkjet-printed inverted-staggered FET on PET. **a** Schematic of a printed inverted-staggered FET heterostructure. Optical microscopy images (dark field) of the **b** inverted-staggered and **c** coplanar FET heterostructures on PET with channel lengths of 50 and 65 μ m, respectively. **d**, **e** Transfer characteristics and **f**, **g** linear output characteristics of the FETs as a function of V_{ds}. **h**, **i** Transfer characteristics of the FETs with observable hysteresis depending on sweep direction at V_{ds} = 1V. **j**, **k** Transfer characteristics of the FETs as a function of bending radius in the *x*-direction at V_{ds} = 1V

Figure 2d-i shows six spectral profiles associated with the most significant sets of elements (namely-component 1: B and N, component 2: Si and O, component 3: Ag and Cu, component 4: C, component 5: Na, C and O, and component 6: Pt and Cu), containing information on their mutual correlation. The spatial cross-sectional distribution of elements is shown as contour maps in the insets. This representation provides a map of components (e.g. BN or CMC) rather than individual elements (insets Fig. 2d-i). The plot of Fig. 2d shows the EDX energy transitions, where the B K_{α} and N K_{α} peaks are predominant in component 1 and the inset in Fig. 2d indicates that this component is entirely contained within the dielectric region, as expected, whereas component 2 (exhibiting predominantly O K_{α} and Si K_{α} peaks) originates from the SiO₂ nanoparticles coating on the PET substrate (Fig. 2e). Figure 2f shows that component 3 mostly contains Ag L_{α} and Cu K_{α} lines, which clearly originate from the silver ink (see inset) in the gate and source electrodes and from the TEM grid. In particular, Fig. 2g, h shows components 4 and 5 associated to CMC and graphene, which are carbon-rich compounds. Specifically, component 4 (Fig. 2g) is dominated by the C K_{α} peak, and the relative contour map (inset Fig. 2g) highlights two high intensity regions for this component, one at the interface with the silver electrode and a second within the boron nitride flakes. We associate the first region with the presence of graphene (highlighted by a red box, inset Fig. 2g), whereas the second can be linked to the CMC stabilizing the h-BN ink. This is corroborated by evidence that component 5 (containing signal from C, O and Na), typical of CMC, is only present within the dielectric region and not at the interface with the silver electrodes (Fig. 2h, inset), as it should be for the carboncontaining binder. Finally, component 6 is composed of Pt M_{α} and Cu K_{α} , which originate from the platinum deposited to protect the area under investigation (Fig. 2i and inset) and from the TEM grid.

Raman spectroscopy (Renishaw 1000 InVia micro-Raman) is used to monitor the quality of materials used in the heterostructure. Figure 2j plots the spectra of inkjet-printed films of graphene (black curve), h-BN (red curve) and graphene/h-BN heterostructure (blue curve), acquired at 514.5 nm on a Si/SiO₂ substrate. For the graphene, the G peak located at ~1580 cm⁻¹, the D peak located at ~1350 cm⁻¹ and the Lorentzian-shaped 2D peak located at ~2695 cm⁻¹ indicate that the graphene film comprised of electronically decoupled graphene layers. In pristine graphene inks, the D peak corresponds to the edges of the submicrometer flakes, rather than to the presence of a large amount of disorder within the flakes^{22, 47}. This is supported by our graphene film showing a low dispersion of G peak, Disp (G) $\approx 0.01 \text{ cm}^{-1} \text{ nm}^{-1}$, which is lower than what expected for disordered carbon⁴⁸ (see more details in 'Methods'). In the case of the h-BN film (red curve), we observe a single peak at 1368 cm^{-1} corresponding to the E_{2g} phonon vibration mode^{49, 50}. Typically for bulk h-BN, this peak is found at 1366 cm⁻¹, whereas the upshifting of the peak indicates the successful exfoliation from the bulk material to few layer h-BN⁵⁰. The Raman spectrum of the graphene/h-BN heterostructure (blue curve) shows the fingerprints of graphene flakes and h-BN flakes. The spectrum is in fact the superimposition of that of the graphene film and the h-BN film.

We then characterised the output and transfer electrical characteristics of both inverted-staggered (Fig. 3a, b) and coplanar (Fig. 3c) graphene/h-BN FETs on PET. For both structures, the transfer characteristics (shown in Fig. 3d, e) are measured (at room conditions) applying drain-source voltages $V_{ds}1$ V, 500 mV and 50 mV, and the output characteristics (Fig. 3f, g) measured at a gate-source voltage $V_{gs} = -2$, 0, and 2 V indicate that drain current (I_d) increases linearly with V_{ds} , which is typical of zero-bandgap semiconductors and consistent with the behaviour of graphene FETs⁵¹. From Fig. 3d, e we observed ambipolar behaviour for both device structures⁵¹ ($V_{ds} = 1$ V) on all the coplanar and staggered graphene/h-BN-printed devices as is expected for graphene-based FETs⁵¹, ⁵². The gate current in all the devices is more than a magnitude lower (<100



Fig. 4 Inkjet-printed FET on textile. a Fabrication steps of the inkjet-printed inverted-staggered FET heterostructure on textile. b FIB-SEM cross-sectional view of the full FET of the left contact (blue), middle channel (orange), and right contact (green). The scalebar is alike for each figure

nA) than the drain current, indicating that the device is modulating current in the graphene channel. When a forward $V_{\rm gs}$ sweep (from negative to positive $V_{\rm gs}$) is applied (red curve) in both coplanar and inverted-staggered heterostructures (Fig. 3h, i) the minimum I_d , corresponding to the charge neutrality point (i.e. the Dirac point in graphene), occurs at positive voltage, which means graphene channel was lightly p-doped. We also noticed a hysteretic behaviour for both devices when a forward gate-source voltage"?> V_{gs} sweep (from more negative to more positive V_{gs}) is applied (red curve), which causes a shift of the Dirac point of ΔV \sim 3 V between forward V_{gs} sweep and backward V_{gs} sweep (as shown in Fig. 3h, i). This is consistent with ΔV already observed in FETs fabricated by CVD-grown graphene and mechanical cleavage graphene⁵³. In our devices, we attribute this effect to capacitive gating created by the oppositely charged ions of residual water in the device, which can enhance the local electrical field at the graphene/h-BN interface and help attract more majority carriers through the metallic contact⁵³.

The field-effect mobility of the coplanar and inverted-staggered devices were derived from the slope of the transfer characteristic according to $\mu = (L/WCV_{ds})/(dI_d/dV_{gs})$, where L (µm) and W (μm) are the channel length and width, respectively, and C is the dielectric capacitance⁵¹. We use $L \approx 50 \,\mu\text{m}$, $W \approx 580 \,\mu\text{m}$ and $L \approx$ 65 µm and $W \approx 500$ µm for coplanar and inverted-staggered FETs, respectively, and the previously calculated dielectric capacitance per unit area of $\sim 8.7 \text{ nF cm}^{-2}$ at $V_{\rm ds} = 1 \text{ V}$. The average field-effect mobility for holes ($\mu_{\rm h}$) and electrons (μ_e) for the coplanar devices are calculated to be $\mu_h \sim$ $150 \pm 18 \text{ cm}^2 \text{ V}^{-1} \text{ s}^{-1}$ and $\mu_e \sim 78 \pm 10 \text{ cm}^2 \text{ V}^{-1} \text{ s}^{-1}$, respectively, whereas having an on/off current ratio (defined as the maximum $I_{\rm d}$ divided by the minimum $I_{\rm d}$) of ~2.5 ± 0.1. The best device demonstrated a mobility of $\mu_{\rm h} \sim 204 \ {\rm cm}^2 \ {\rm V}^{-1} \ {\rm s}^{-1}$ and $\mu_{\rm e} \sim 118$ cm² V⁻¹ s⁻¹. For the inverted-staggered devices, we find an on/off ratio of ~1.5 ± 0.2, $\mu_{\rm h}$ ~32 ± 5 cm² V⁻¹ s⁻¹ and $\mu_{\rm e}$ ~10 ± 4 cm² V ⁻¹ s⁻¹, which are one magnitude lower than the coplanar structure field-effect mobility on PET. We attribute this decrease in

mobility to the rougher surface of the h-BN layer (root mean squared roughness, $R_q \sim 68$ nm) in contrast to the PET film (R_q ~15.2 nm), which could affect the stacking quality of the graphene flakes. Such difference between $\mu_{\rm h}$ and $\mu_{\rm e}$ corresponds to a preferential hole conduction over electron conduction, which may be due in part to the unintentional doping of the graphene channel^{52, 54}. Moreover, a preferential hole conduction has been reported for various graphene FETs on SiO₂ substrate, including FETs made with graphene from CVD⁵⁵ and mechanical exfoliation⁵². The field-effect mobility of our graphene/h-BN heterostructure FET is higher than that of printed CNT FETs ($\mu \sim 20 \text{ cm}^2 \text{ V}^{-1} \text{ s}^{-1}$, on/off $\sim 10^4$)⁵⁶ and is about 15 times higher than μ in the organic ($\mu \sim 10.5 \text{ cm}^2 \text{ V}^{-1} \text{ s}^{-1}$, on/off $\sim 10^6$)⁵⁷ and metal-oxide transistors ($\mu_e \sim 9 \text{ cm}^2 \text{ V}^{-1} \text{ s}^{-1}$, on/off $\sim 10^7$)⁵⁸, while comparable to that of inkjet-printed graphene FETs ($\mu \sim 95 \text{ cm}^2$ V^{-1} s⁻¹, on/off ~10)²² and reduced graphene oxide FETs (μ ~210 $cm^2 V^{-1} s^{-1}$, on/off ~3)⁵⁹. However, the on/off ratio is lower than that of printed organic, metal-oxide and CNT FETs^{57, 58}, but consistent with the on/off measured on previously reported FETs from printed graphene^{22, 59}. An array of coplanar FETs is shown in Supplementary Fig. 4a and b. The flexibility of the coplanar and inverted-staggered graphene/h-BN FET was tested as a function of bending radius using metal rods and the resulting transfer characteristics were compared (Fig. 3j, k). For the coplanar FETs, we observed no change in μ_h at a bending radius of 8 mm (~1% uniaxial strain along the x axis), while $\mu_{\rm h}$ drops to ~19 cm² V⁻¹ s⁻¹ at a smaller bending radius (4 mm, ~2% uniaxial strain along the x axis). For the inverted-staggered FETs, $\mu_{\rm h}$ drops to $\sim 6 \text{ cm}^2 \text{ V}^{-1} \text{ s}^{-1}$ at a bending radius of 8 mm and remains constant until 4 mm bending radius, as shown in Supplementary Fig. 4c. The stability of a printed coplanar graphene/h-BN FETs was also examined over a 2 year period when stored at room temperature and pressure, and we observe that that devices are still operational (Supplementary Fig. 4d). We attribute this behaviour to both the environmental stability of graphene⁶⁰ and the longevity of the h-BN encapsulating properties⁶¹.



Fig. 5 Electrical characterisation of FET on textile. **a** Optical microscopy image of the inverted FET on polyester with a channel length of 80 μ m. **b** Image of an array of FETs on textile. **c** Transfer and **d** output characteristics of the textile FET at $V_{ds} = 1$ V. **e** Transfer characteristics of the textile FET as a function of bending radius at $V_{ds} = 1$ V. **f** Transfer characteristics of the textile FET before and after several washing cycles at $V_{ds} = 1$ V

All inkjet-printed graphene/h-BN field-effect heterostructures on textile. The roughness (R_q) of textiles affects the electrical properties of printed devices. Therefore, we minimised this effect by adopting a planarization layer. Typical planarization layers such as polydimethylsiloxane (PDMS), polyimide, polyurethane or poly(vinyl alcohol) (PVA) decrease the rms roughness and thus improve the device performance⁶². For example, ref. ⁶³ used laminated polyurethane ($t \sim 20-50 \,\mu\text{m}$) on polyester reducing R_q from 10 μ m to < 5 μ m⁶³, whereas ref. ⁶⁴ used spin-coated polyimide ($t \sim 500$ nm) on polyimide, reducing R_{q} from 2.5 to 0.3 nm⁶⁴. Here we employed polyester satin fabric (Wuxi Yihong Textile Co.) as a substrate for our textile graphene/h-BN FETs because it is highly durable and represents about ~80% of the synthetic fibre market. Polyurethane-coated fabric is identified as having the lowest R_q (~14.8 µm) after one coating layer ($t \sim 600$ nm), as compared to the other coating layers where $R_q \sim 25-34$ µm was measured (Supplementary Fig. 5b). We select a ~12 µm thick polyurethane coating layer when fabricating our FET devices on textile as it shows the minimum roughness ($R_q \sim 1.9 \pm 0.5 \,\mu\text{m}$) for the least number of coatings (Supplementary Fig. 5c). Initial attempts to print thin (between 100 and 200 nm thick) graphene channels (from stripes with $L \sim 2 \text{ mm}$ and $W \sim 1 \text{ mm}$ in a coplanar heterostructures, resulted in highly resistive channel (channel resistance, $R_c > 40 \text{ M}\Omega$) due to the R_q of the substrate being orders of magnitude higher the channel thickness, which hinders the development of a coplanar FET structure. Moreover, increasing the thickness of the graphene layer further will inevitably decrease the transistor mobility²². On the other hand, the invertedstaggered heterostructure offers a higher resilience to roughness variation of the substrate than the coplanar structure, given that the channel sits on the top of a thick h-BN dielectric layer, which in this case shows R_c of ~10 k Ω for a 200 nm thick graphene

channel. We thus adopt this layout for our graphene/h-BN FET on textile.

Electronic devices on textile require not only flexibility but the ability to conform with the textile with little or no effect on the electrical and optical performances. Hence, we replace the printed silver electrodes with a highly conformable conductive polymer such as poly(3,4-ethylenedioxythiophene) polystyrene sulphonate (PEDOT:PSS) (Sigma-Aldrich, 739316, 0.8 w/v in H_2O)⁶⁵. It is worth noting that the PEDOT:PSS ink ($Z \approx 30$) was successfully jetted from the inkjet nozzles despite being slightly outside the previously found Z range $(2 < Z < 24)^{22, 37}$. Figure 4a shows each step of the inkjet-printed graphene/h-BN heterostructure on textile. The all inkjet-printed textile FET were fabricated as follows; first we printed a PEDOT:PSS film as the gate electrode (t $\sim 6.5 \,\mu$ m, determined by profilometry), followed by a h-BN dielectric layer ($t \sim 2 \,\mu\text{m}$, corresponding to a capacitance of $\sim 7 \,\text{nF}$ cm⁻²) that also reduces residual roughness of the polyurethane planarization layer ($R_q \sim 1.9 \,\mu$ m). Then we printed a $\sim 200 \,\text{nm}$ thick graphene channel and finally deposited the PEDOT:PSS source and drain contacts ($t \sim 800$ nm). We found that the R_q of the channel decreased further from ~1.9 µm to ~588 nm (as determined by AFM), thanks to the PEDOT:PSS and h-BN bottom layers in the inverted-staggered configuration. Similarly to the FET heterostructures on PET, the samples were annealed at 100 °C for 1 h to remove residual solvent in the devices. Figure 4b shows FIB-SEM cross-sectional views of the FET heterostructure on textile of the regions under the left contact (blue), the middle channel (orange) and the right contact (green), where we identify the graphene layer, h-BN layer and PEDOT:PSS layers in the respective configurations. The layers are continuous and no pinholes or delaminating areas are visible, even where the substrate varies locally, showing the effectiveness of the planarization and



Fig. 6 Fully inkjet-printed logic. **a** Optical microscopy image (dark field) of an integrated circuit demonstrating an all inkjet-printed complementary graphene inverter as shown in the schematic. **b** The measured resistances of the top (R_p) and bottom (R_n) GFET as a function of the input voltage. Segments of the curves displaying *n*-type (*p*-type) behaviour are drawn in red (blue). **c** The measured static voltage transfer characteristic of the printed inverter. The inverter is capable of signal inversion between the maximum and minimum of the transfer characteristic. **d**, **e** Digital $V_{\rm IN}$ black) and $V_{\rm OUT}$ (red) waveforms measured on one of the fabricated inverters at $V_{\rm DD} = 1$ V under ambient conditions. **f** Circuit diagram of a multifunctional printed logic gate with two inputs (A and B) and one output (OUT) with truth table of an OR logic gate. **g** Digital waveforms measured in an OR logic gate. The gate voltage $V_{\rm GS}$ takes three discrete levels labelled by the values of the corresponding Boolean variables A and B

the h-BN layers in minimising the channel roughness. Also in this case, the preferential horizontal orientation of the h-BN flakes in the dielectric layer of the channel region prevents the formation of large vertical gaps, thus avoiding pin-holes. Figure 5a shows an optical microscopy image of the graphene/h-BN FET heterostructure on textile, and Fig. 5b shows an all inkjet-printed array of FET heterostructures on polyester fabric. The geometry of all the graphene/h-BN textile FETs is $L \approx 80 \,\mu\text{m}$, $W \approx 500 \,\mu\text{m}$ and $t \approx$ 200 nm. Figure 5c and d shows, respectively, the transfer characteristic at $V_{ds} = 1$ V and the output characteristic for different gate voltages $V_{gs} = -2$, 0 and 2 V. The average fieldeffect mobility of the devices is $\mu_{\rm h} \sim 91 \pm 29 \text{ cm}^2 \text{ V}^{-1} \text{ s}^{-1}$ and $\mu_{\rm e} \sim 22 \pm 10 \text{ cm}^2 \text{ V}^{-1} \text{ s}^{-1}$, respectively, whereas the on/off ratio is ~1.23 \pm 0.3. This behaviour is expected, as μ of printed graphene channels increases with thickness until percolation is reached²². Our μ is two to three magnitudes larger than what has currently been achieved for organic FETs on e-textile fibres ($\mu \sim 0.01-0.3$ $cm^2 V^{-1} s^{-1}$, on/off ~10³)^{16, 66} while reaching one magnitude greater mobility than inverted-staggered FETs spin-coated on polyester textile with a ion gel dielectric/P3HT smoothing layer (μ $\sim 7 \text{ cm}^2 \text{ V}^{-1} \text{ s}^{-1}$, on/off $\sim 10^5$)⁶⁷. We also printed the same inverted FET with ~100 nm graphene channel thickness, reaching fieldeffect current modulation (Supplementary Fig. 6a). However, the $R_c \sim 450 \,\mathrm{k}\Omega$ in this case is more than one order of magnitude higher than the inverted FET on PET. By increasing the graphene thickness to ~200 nm, we reduce R_c to ~10 k Ω , and in this case we likely reached the bulk conductivity regime, as already shown for inkjet-printed graphene patterns and FET channels²² >25 nm thick. It is worth also noting that our device operates at low voltage (<5 V), which is a key requirement for the low-power consumption of textile electronics devices⁶⁸.

Textiles normally undergo naturally occurring tensile strain as well as washing steps⁹ so it is important that electronic devices integrated within these textiles also withstand these steps. Therefore, we investigated the effect of bending (Fig. 5e) and

washing cycles (Fig. 5f) on the mobility of our graphene/h-BN FET heterostructures on textile. We find that $\mu_{\rm h}$ decreases to ~41 $\text{cm}^2 \text{V}^{-1} \text{s}^{-1}$ at 8 mm bending radius (~2% uniaxial *x*-axis strain) and to $\sim 27 \text{ cm}^2 \text{ V}^{-1} \text{ s}^{-1}$ at 4 mm bending radius ($\sim 4\%$ uniaxial xaxis strain, as shown in Supplementary Fig. 4c), with the on/off ratio not significantly changing (Δ on/off ~ 0.05), thus indicating the devices remain operational while under strain (Fig. 5e). Figure 5f shows the transfer characteristics of the invertedstaggered textile FET as a function of washing cycles (see 'Methods'). To protect the printed FET, a waterproof polyurethane-protective layer (WBM Seam Tapes) was hot pressed (PixMax Swing heat press) around the top and bottom of the devices at 120 °C for 5 s. The graphene/h-BN FET heterostructure was functional up to at least 20 washing cycles without any significant change to the performance of the devices in terms of mobility (Supplementary Fig. 6b) and on/off ratio. The drain current, however decreased from 94 to ~50 µA after 10 washing cycles and maintains this value over 20 washing cycles, most likely due to the increasing channel resistance as a result of the bending the device experienced during washing. The demonstration of washability is important as it prolongs the device lifetime, avoids replacement costs and improves compatibly with current textile industry technologies.

Electronic circuits based on all-printed 2D-material heterostructures. The versatility of the inkjet-printed FETs allows to arbitrarily design electronic circuits. The goal of an 'all inkjetprinted' circuit with 2D-material heterostructures has been a dream pursued for long time³⁰. To verify the suitability of our technology for fully printed, flexible electronic circuits with 2D materials, here we demonstrate an all inkjet-printed complementary inverter (Fig. 6a–e), a reprogrammable logic OR gate (Fig. 6f, g), a single transistor memory cell (Supplementary Fig. 7a, b) and p-type and n-type logic inverters (Supplementary Fig. 8a, b) using the all-printed coplanar graphene/h-BN FET

heterostructures. Figure 6a shows the optical microscopy image (dark field) of an all inkjet-printed complementary graphene/h-BN inverter, whereas the schematic of the inverter is shown beside it. In Fig. 6b, two printed FETs were connected to a power supply $V_{\rm DD} = 1$ V to create a complementary graphene inverter⁶⁹, with the coplanar graphene/h-BN heterostructures. The Dirac voltages of both FETs were identical at low biases. When $V_{DD} = 1$ V was applied, the larger gate (i.e. input) voltage was required to reach the Dirac point of the top FET with respect to that of the bottom FET^{70, 71}. This is illustrated in Fig. 6b in which the resistance maximum of the top FET is shifted to larger input voltages compared to that of the bottom FET. The complementary operation of the FETs was obtained between their Dirac voltages (the area shaded in yellow), where the top FET operated in the p-type and the bottom FET in the n-type regime⁶⁹. Although the strongest signal inversion is obtained in the complementary mode, the inverter is capable of signal inversion in a slightly larger input voltage range⁶⁹, i.e. in the range between the maximum and minimum of the static voltage transfer characteristic shown in Fig. 6c. As this range is approximately equal to the rail-to-rail voltage range (0 to V_{DD} = 1 V), the inverter correctly inverted the input digital signal, as shown in Fig. 6c. In Fig. 6d, digital waveform for the input signal (black line) has logical high $V_{DD} = 1$ V and logical low 0 V. The output signal of the inverter (red line) with the input signal is shown in Fig. 6d in the same scale, whereas the output signal is also plotted in Fig. 6e. In principle, the inverter is capable of in/ out signal matching because the offsets of the input and output signals are the same $(V_{\rm DD}/2)^{72}$. The output voltage swing is 10% of the input voltage swing, indicating low voltage gain $(A = dV_{OUT}/dV_{IN} \approx 0.1)$ of the inverter. The reason for the low gain is a very thick (~1 µm) gate insulator, which corresponds to a very large equivalent oxide thickness (EOT) of 557 nm. Nevertheless, the obtained gain is still larger than that of the first exfoliated complementary graphene inverters with EOT = 300nm⁶⁹.

We also realized an OR logic gate to demonstrate the versatility of the printed graphene/h-BN FET heterostructures. Two printed FETs were connected to a low-voltage power supply $V_{DD} = 0.2 \text{ V}$ as shown in Fig. 6f. We left the gate of the top FET floating (i.e. no bias) and used it as a resistive load (i.e. pull-up resistor) of the bottom FET. Two input logic signals $V_{\rm A}$ and $V_{\rm B}$ (corresponding to Boolean variables A and B) were connected to the gate of the bottom graphene field-effect transistor (GFET) via two identical resistors. This gives for the gate voltage of the bottom GFET $V_{\text{GS}} = (V_{\text{A}} + V_{\text{B}})/2^{74}$. As the input logic signals had a low $V_{\rm L}$ (Boolean 0) or high $V_{\rm H}$ (Boolean 1) voltage level, the gate voltage had three discrete levels: low $V_{\rm L}$ (both inputs 0), high $V_{\rm H}$ (both inputs 1), and half way between $(V_{\rm L} + V_{\rm H})/2$ (inputs different). Depending on the position of the gate voltage levels with respect to the Dirac voltage, different logic gates can be obtained⁷⁴. Figure 6g shows the input and output voltage signals in an OR gate. The OR logic function was obtained by choosing the input levels such that the Dirac voltage of the bottom GFET is exactly half way between the mid and high gate level⁷⁴. The low output voltage swing originates from the bottom FET operating very close to the Dirac point due to the small difference between the high $(V_{\rm H} = 0.4 \text{ V})$ and low $(V_{\rm L} = V_{\rm H} - V_{\rm DD} = 0.2 \text{ V})$ level and from the thick gate insulator in the GFETs.

These results demonstrate the robustness of our technology based on all inkjet-printed 2D-material heterostructures to fabricate flexible and integrated electronic circuits, such as memories and logic gates exhibiting the same functionality as the some of the first circuits fabricated by standard lithographic methods with heterostructures of 2D materials ⁶⁹.

Discussion

We demonstrated fully inkjet-printed dielectrically gated fieldeffect transistors based on graphene/h-BN heterostructures for flexible and textile electronic circuits. The graphene/h-BN heterostructure FETs on polyester textile show μ_h and μ_e up to 91 cm² V⁻¹ s⁻¹ and 22 cm² V⁻¹ s⁻¹ in ambient conditions, withstand up to ~4% strain and are washable for up to at least 20 cycles. The viability of the printed graphene/h-BN heterostructures FETs for electronic circuits was also demonstrated with fully printed complementary inverters, logic gates and rewriteable volatile memory.

Methods

Ink preparation. The graphene ink was prepared by dispersing graphite flakes (10 mg ml⁻¹, Sigma-Aldrich No. 332461, <100 µm size) and ultrasonicating (Fisherbrand FB15069, Max power 800 W) for 9 h in NMP¹⁹, providing surfactant/ polymer-free exfoliation of graphite. The graphene ink in NMP was then solvent exchanged to ethanol so that we facilitate solvent removal at ambient temperature during printing, thus improving the uniformity of the multi-layer deposition²⁵. The h-BN ink was prepared by mixing h-BN powder (10 mg ml⁻¹, Goodfellows B516011, <10 µm size) with deionized water and carboxymethylcellulose sodium salt (CMC, average molecular weight M_W = 700,000, Aldrich No. 419338) (3 mg ml ⁻¹), a biocompatible and biodegradable stabilisation agent and rheology modifier²¹ The h-BN/CMC mixture was then processed with a shear fluid processor, (i.e. a microfluidizer, M-110P, Microfluidics International Corporation, Westwood, MA, USA) with a Z-type geometry interaction chamber with microchannels ~87 um wide for 50 cycles, at 207 MPa system pressure and at room temperature (20 °C)²¹. We used the microfluidic process to disperse and exfoliate h-BN while the high shear rate generated ($\dot{\gamma} \sim 9.2 \times 10^7 \, \text{s}^{-1}$) helped to achieve high concentration dispersions²¹. The h-BN and graphene dispersions were then ultracentrifuged (Sorvall WX100 mounting a TH-641 swinging bucket rotor) at 3 k rpm (20 min) and 10 k rpm (1 h), respectively, to remove thick flakes, which would clog the printer nozzles. Subsequently, the supernatant (i.e. top 70%) was decanted for further characterisation.

Solvent exchange. First (~20 ml) of graphene/NMP ink is passed through a PTFE membrane (Merck Millipore, $0.1 \,\mu$ m). The process is hastened with the use of Büchner flask which is attached to a vacuum pump. The membrane is then placed into 5 ml of ethanol and bath sonicated (Fisherbrand FB15069, Max power 800 W) for 10 min to redisperse the flakes into the ethanol.

Ink characterisation. The surface tension is measured using the pendent drop method (First Ten Angstroms FTA1000B). The shape of the drop suspended from a needle results from the relationship between the surface tension and gravity. The surface tension is then calculated from the shadow image of a pendant drop using drop shape analysis. A parallel plate rotational rheometer (DHR rheometer TA instruments) is used to evaluate the viscosity as a function of shear rate, the infinite-rate viscosity for each ink is found. Ink density is evaluated from a (Sartorius ME5) microbalance where the density is $\rho = m/V$, *m* is the mass and *V* the volume.

Optical absorption spectroscopy. The flake concentration in the graphene and h-BN inks are obtained via the Beer-Lambert law, which correlates the absorbance $A = \alpha cl$, with the beam path length l (m) the concentration c (gl⁻¹) and the absorption coefficient α (lg⁻¹ m⁻¹). The h-BN and graphene inks were diluted 1:20 with water/CMC and ethanol, respectively. Absorption coefficients of $\alpha_{h-BN} \sim 2350$ lg⁻¹ m⁻¹ for the h-BN ink⁷⁶ and $\alpha_{GR} \sim 2460 \log^{-1} m^{-1}$ for the graphene ink¹⁹ at 660 nm were utilised. The optical bandgap of the h-BN ink is obtained using E_g defined by hc/λ_g , where h is the Planck constant, c is the speed of light in vacuum and λ_g is the resonance wavelength of the peak.

Raman spectroscopy. Films of each ink and a graphene/h-BN heterostructure are inkjet-printed on Si/SiO₂ substrate and the Raman spectra are acquired with a Renishaw 1000 InVia micro-Raman spectrometer at 457, 514.5, and 633 nm and a 20× objective, with an incident power of below ~1 mW to avoid possible thermal damage. The system is within 1.5 cm^{-1} spectral resolution at 514 nm. The G peak dispersion is defined as Disp(G) = $\Delta Pos(G)/\Delta\lambda_L$, where λ_L is the laser excitation wavelength. In disordered carbon, the G peak position, Pos(G), increases as the excitation wavelength λ_L decreases from the IR to UV⁷⁷. Therefore, the dispersion of the G peak, increases with disorder and allows one to discriminate between disorder localised at the edges or in the bulk of the samples^{47, 77}.

Scanning electron microscopy. Scanning electron microscopy images were acquired with a high resolution Magellan 400L SEM. The field emission gun was operated at an accelerating voltage of 5 kV and gun current of 6.3 pA. Images were obtained in secondary electron detection mode using an immersion lens and TLD

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detector. A 3-5 nm platnium coating was sputtered (Emitech sputter coater) on to the surface of the h-BN flakes to reduce the build-up of electrons.

Transmission electron microscopy. Drops of boron nitride and graphene inks were dispensed on holey carbon TEM grids and then analysed in a FEI Osiris operating in bright field mode at 80 kV. A FEI Helios dual beam Focus Ion Beam/ Field Emission Gun-Scanning Electron Microscope (FIB/FEG-SEM) was employed to prepare lamellae for STEM imaging and analysis. The same microscope was used for slice and view imaging. EDX data were acquired using a FEI Osiris TEM equipped with a high-brightness Schottky X-FEG gun and a Bruker Super-X EDX system composed of four silicon drift detectors, each ~30 mm² in area and arranged symmetrically around the optical axis to achieve a collection solid angle of 0.9 sr. The windowless design of the detector allows qualitative mapping of light elements. Spectrum images were acquired with an acceleration voltage of 80 kV, a spatial sampling of 10 nm pixel⁻¹ and 100 ms pixel⁻¹ dwell time. We employed multivariate analysis to localise EDX signals from compounds by applying a statistical analysis algorithm (non-negative matrix factorisation-NMF in this case)⁷⁸ to the EDX dataset, comprising several thousand spectra, and identifying correlations between spectral features. Data were acquired with Tecnai Imaging and Analysis (TIA) and analysed within Hyperspy⁷⁹, an open source analysis tool-kit where statistical analysis algorithms such as NMF, are implemented.

Atomic force microscopy. A Bruker Dimension Icon working in peakforce mode was used. From the centrifuged graphene and h-BN dispersions, samples were collected and after 10 times dilution they were drop casted onto pre-cleaned (with acetone and isopropanol) Si/SiO₂ substrates wafer substrates. For the graphene and h-BN inks, 150 flakes were counted to determine the statistics for the lateral size and thickness. For the rms, roughness measurement areas of 50 μ m² were scanned.

Electrical characterisation. All devices were measured with a probe station (Summit 12000, Cascade Microtech) that is connected to a semiconductor device analyser (Agilent Technologies, B1500A) to obtain I-V curves. We use a sweeping time of 0.59 V s⁻¹ in all devices.

Inkjet printing. We used a DoD ink-jet printer (Fujifilm Dimatix DMP-2800) equipped with a 21 µm diameter nozzle (Fujifilm DMC-11610) where the volume of individual droplets from this nozzle is ~10 pl. The platen temperature was kept as 20 °C throughout printing of heterostructures. Each ink was printed at a maximum jetting frequency of 2 kHz. During droplet ejection a primary drop may be followed by secondary (satellite) droplets which need to be avoided during printing⁸⁰. In addition, nozzle clogging can be an issue unless the particles are \sim 1/50 or less the nozzle diameter²². When inkjet printing, the ejected drop contacts the substrate and spreads according to Young's equation, $\gamma_{SV} - \gamma_{SL} - \gamma_{LV} \cos \theta_c = 0$ (where γ_{SV} is the solid-vapour surface energy, γ_{SL} the solid-liquid interfacial tension and γ_{LV} the liquid-vapour surface tension). The γ_{LV} of the graphene ink (30 mN m⁻¹) and PEDOT:PSS ink (44 mN m⁻¹) is minimised so that the droplets will coalesce even on low $\gamma_{\rm SV}$ surfaces (such as polyurethane) allowing uniform printed lines. Furthermore, similarly to CNTs^{81} low boiling point solvents (${\leq}100\,^\circ$ C) are used to disperse the graphene, h-BN and PEDOT:PSS inks, which evaporate quickly minimising both the transport of particulates (which causes 'coffee ring') and the re-dispersion of material at the heterostructure interfaces, thus improving the morphological uniformity of the layered arrangement. The drop then dries through solvent evaporation and the resulting thickness will depend on the number of droplets delivered per unit area (controlled by the interdrop spacing, i.e. the centre - to - centre distance between two adjacent deposited droplets), the drop volume and the concentration of material in the ink.

Washability test. For each washing test, the sample was washed by immersion in a sealed beaker of 100 ml deionized water containing 2 mg ml⁻¹ sodium carbonate and 5 mg ml⁻¹ soap at 50 °C, and tumble washed for 30 min according to industry standards⁹.

Data availability. The data that support the findings of this study are available from the corresponding author upon request.

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Author contributions

F.T. conceived the experiments. T.C. and F.T. designed the experiments. T.C. developed the inks, printed devices and circuits and conducted UV–vis, AFM, SEM, Raman, impedance characterisation, optical microscopy, profilometry, electrical measurements of the FETs including bending, stability and washing tests. S.C., G.D. and C.D. performed all TEM, FIB and EDX and assisted with SEM. J.R. and C.W. contributed to the development of the textile planarization layer. J.M.K., T.C. and F.T. analysed the experimental data and discussed the results. R.S. designed the electronic circuits and characterised the device performance with the assistance of T.C. and A.M. The manuscript was written by T.C., F.T. and R.S, in close consultation with other authors.

Additional information

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